

## **Technical Data Sheet**

MODEL NO: S282ANW4-JH 0402Package 1.0\*0.5mm Chip LEDs

### Features:

• Package in 8mm tape on 7" diameter reel

• Compatible with automatic placement equipment

• Compatible with reflow solder process

### Applications:

Indicators

• Automotive: backlighting in dashboard and switch

Backlight for LCD

Dice material	Emitted color	Lens Color
InGaN	White	Yellow diffused

## Electrical/Optical Characteristics(Ta=25 $^{\circ}$ C)

Parameter	Test	Cumbal	Value			Linit
	Condition Symbol	Symbol	Min	Тур	Max	Unit
Spectral half bandwidth	IF=2mA	Δλ		35		nm
CIE Coordinates	IF=20mA	Х	0.234		0.2855	nm
		Υ	0.2123		0.2974	
Forward voltage	IF=20mA	VF	2.8		3.6	V
Luminous intensity	IF=20mA	lv	160	250	400	mcd
Viewing angle at 50% lv	IF=20mA	2 <i>0</i> 1/2		120		Deg
Reverse current	V <sub>R</sub> =5V	lr			10	μΑ

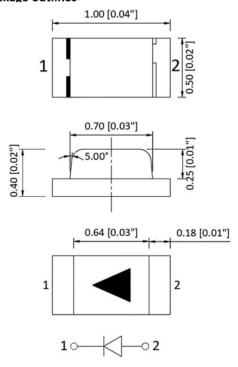


## Absolute Maximum Ratings(Ta=25°C)

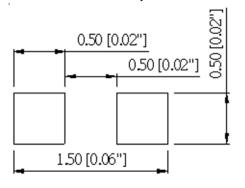
Parameter	Symbol	Value	Unit
Power dissipation	Pd	102	mW
Forward current	lF	30	mA
Reverse voltage	VR	5	V
Operating temperature range	Тор	-40 ~+80	$^{\circ}\!\mathbb{C}$
Storage temperature range	Tstg	-40 ~+85	$^{\circ}\!\mathbb{C}$
Peak pulsing current (1/8 duty f=1kHz)	IFP	125	mA

# PACKAGING DIMENSIONS (mm):

#### Package outlines.



#### Recommend Pad Layout



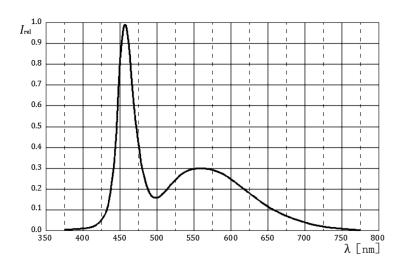




# Typical Electro-Optical Characteristics Curve:

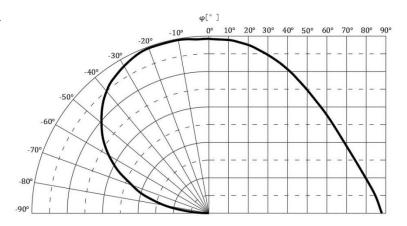
## **Relative Spectral Emission**

IF=5mA,Ta=25°℃



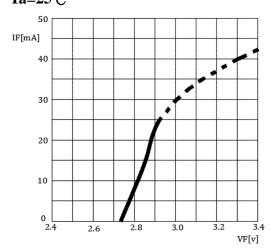
#### **Radiation Characteristics**

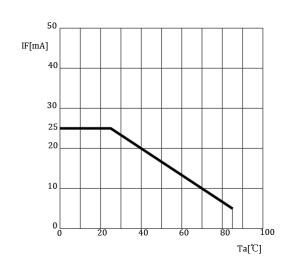
**IF=10mA,Ta=25℃** 



### Forward Current vsForward Voltage Forward Current Derating Curve

Ta=25°C





### **Precautions For Use:**

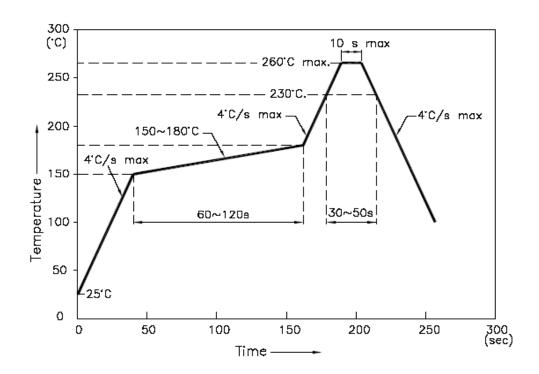
#### Over - current - proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)

#### Storage

- 1. The operation of temperature and R.H. are :  $5^{\circ}$ C  $\sim 30^{\circ}$ C, 60%R.H. Max.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1.5 year (from production date).
- 3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is :  $60^{\circ}\text{C}\pm5^{\circ}\text{C}$  for 15hrs.

### ■ Reflow Temp/Time



#### NOTES:

- 1. We recommend the reflow temperature  $245^{\circ}\text{C}(\pm 5^{\circ}\text{C})$ .the maximum soldering temperature should be limited to  $260^{\circ}\text{C}$ .
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

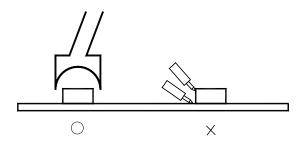


### ■Soldering iron

Basic spec is  $\leq$  5sec when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec ). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

#### **■**Rework

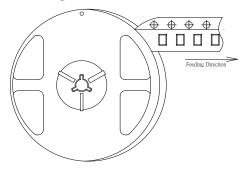
- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



■ Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow \ solder etc.

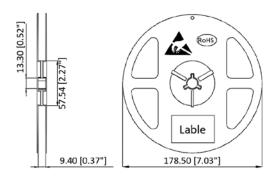


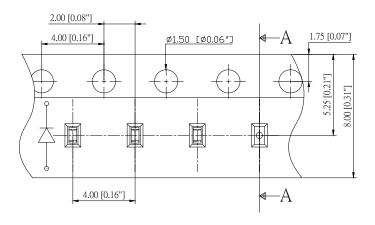
### **■Feeding Direction**

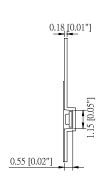


### **■**Dimensions of Tape (Unit: mm)

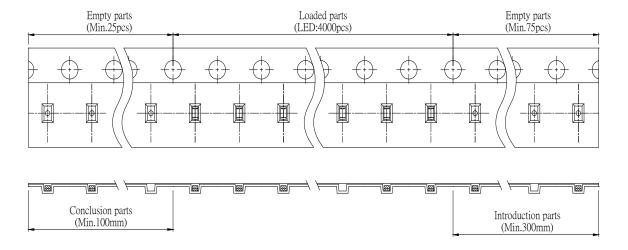
### Dimensions of Reel (Unit: mm)







### **■**Arrangement of Tape



#### ■Note

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two.
- 3. 4,000 pcs/Reel.